The Development and the commercialization of the Mask Aligner for wafer Midas System will continue to grow along with the value creation for our customers,

http://www.aligner.co.kr





The MDA-20000SA is a brand new model of Full-field lithography systems. This brand new Semi Auto Aligner platform offers a higher Overlay Accuracy and more reliable operation.

The System can apply large area 20 inch substrates with UV Exposure.

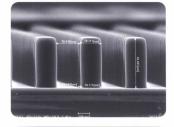
The System is being successfully used in the Manufacturing of Flat panel devices, Touch Panel devices and other Technologies requiring fine geometry printing & precision Alignment.

This System has higher productivity and easy to control.











ITEM	SPECIFICATIONS	
Substrate Size	Costomized (large area)	
UV Lamp Power	5 kW	
Resolution	down to 10um	
Alignment Accuracy	± 1 um	
Lamp Uniformity	≤± 5%	
Uniform Beam Size	24×24 inch	
Beam Intensity	15~20mW/cm² (Broad Band)	
Exposure Time	0.1 to 999.9 sec	
Motorized	Microscope X, Y -axis, Zoom and Focus Stage X, Y, θ and Z-axis	
Process mode	Hard, Soft and Proximity	



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